Pt and Au shell - bimetallic core electrocatalysts through partial electroless replacement of metal (M) deposits by Pt or Au (M: Pb, Cu, Co, Ni)



Principle of electroless replacement of metals "transmetalation"

 $M_{noble}^{n+} + n/m M \rightarrow M_{noble} + n/m M^{m+}$

 $\begin{array}{cc} M_{noble}^{n^+} + n \ e^- \leftrightarrow M_{noble} & E^0_{noble} & E^0_{noble} - E^0 > 0 \\ M^{m^+} + m e^- \leftrightarrow M & E^0 \end{array}$

e.g

 $\begin{array}{c} \text{PtCl}_{6}^{2^{*}} + 2 \text{ M} \rightarrow \text{Pt} + 2 \text{ M}^{2^{*}} + 6 \text{ Cl}^{-} \\ \text{M: Pb, Cu, Co, Ni} \\ \text{2 AuCl}_{4}^{-} + 3\text{M} \rightarrow 2 \text{ Au} + 3 \text{ M}^{2^{*}} + 8 \text{ Cl}^{-} \\ \text{PtCl}_{6}^{2^{+}} + 4\text{e}^{-} \leftrightarrow \text{Pt} + 6\text{Cl}^{-} \text{ E}^{0} = +0.744 \\ \text{V} \\ \text{AuCl}_{4}^{-+} 3\text{e}^{-} \leftrightarrow \text{Au} + 4\text{Cl}^{-} \text{ E}^{0} = +1.002 \text{ V} \end{array} \qquad \begin{array}{c} \text{Cu}^{2^{+}} + 2\text{e}^{-} \leftrightarrow \text{Cu} & \text{E}^{0} = +0.340 \text{ V} \\ \text{Pb}^{2^{+}} + 2\text{e}^{-} \leftrightarrow \text{Pb} & \text{E}^{0} = -0.126 \text{ V} \\ \text{Ni}^{2^{+}} + 2\text{e}^{-} \leftrightarrow \text{Ni} & \text{E}^{0} = -0.257 \text{ V} \\ \text{Co}^{2^{+}} + 2\text{e}^{-} \leftrightarrow \text{Co} & \text{E}^{0} = -0.277 \text{ V} \end{array}$

favourable exchange



Characteristics of the presented method variant

Thick electrodeposits of M (Pb, Cu, Co, Ni) are electrodeposited (equivalent of 300-1500 flat ML) on glassy carbon (GC) substrates:

- avoid complete M dissolution; ensure good GC coverage
- form Pt or Au-shell M-containing-core particles

(use the method for catalysts with non-noble/noble metal interactions)

- tune the composition of the Pt-M, Au-M bi-metallic catalysts.
- Electrochemical treatment (positive potentials):
- ensure that only particles with defect-free Pt or Au shells remain

Room temperature during all process steps (no annealing):

- skip energy and labour intensive step
- study of interactions of the non-alloyed Pt-M core to the Pt shell



SEM and EDS of indicative M, Pt(M) and Au(M) deposits







exchange

activation







SEMs of M, Pt(M) and Au(M) tested





Pt(Cu 28%) Pt(Pb 27%) (from1000 ML)



Pt(Ni 23%) (from 300 ML)



Pt(Co 27%) (from 300 ML)





Au(Cu 32%) (from1500 ML)



Au(Pb 20%) (from1000 ML)



Au (Ni 5%) (from 300 ML)



Au (Co 4%) (from 300 ML)



Electrochemical characterisation-I



> Surface electrochemistry same as of bulk Pt and Au: only Pt or Au on the surface

Electroactive surface areas: 2-8 - fold increase from geometric area



Electrochemical characterisation-II





Hydrazine oxidation on Pt(Cu)

Formic acid oxidation on Pt(Pb)

Cu UPD would hinder hydrazine oxidation: Cu does not re-deposit from the core to the Pt shell

> Pb UPD would catalyze formic oxidation: Pb does not re-deposit from the core to the Pt shell



Sputter-etch AES characterisation





Hydrogen evolution reaction (HER)



unaffected HER at Pt(Pb):

no DFT predictions; lower Wegner-Scheizer radius but higher Pauling electronegativity suppression of HER at Pt(Co), Pt(Ni) and Pt(Cu): weakening of the Pt(M)-H_{ads} bond strength

~ d-band center (ϵ_d) lowering due to strain and ligand effects

(DFT predictions by Nørskov and coworkers; experimental evidence)

hydrogen binding energy trends

(DFT predictions by Mavrikakis and coworkers)

candidates for hydrogenation reactions

(intermediate M-H bond strength)



Oxygen reduction reaction (*ORR***)**





Oxygen reduction reaction (ORR)



slight suppression of ORR at Pt(Co), Pt(Ni) and Pt(Cu):

large ε_d down-shift due to larger ligand and strain effects by nonalloyed M regions in the core

Further decrease of Pt-O bond strength (increase in ΔE_0)but also of dissociative O₂ adsorption





Oxygen reduction reaction (ORR)



enhancement of ORR at Au(Cu), Au(Ni) and Au(Co):

-difference in ORR mechanism

-no oxides present

-extraordinary properties (increased molecular oxygen adsorption) of very small particles or very thin films of Au



Methanol oxidation reaction (MOR)



- enhancement of MOR at Pt(Cu), Pt(Pb)
- decrease at Pt(Ni), Pt(Co)
- (≠literature for alloys)



 enhancement of MOR short term stability at Pt(Cu), Pt(Pb), Pt(Ni), Pt(Co)
(~literature for tolerance to CO poisoning)

Interplay between CO poisoning and MeOH chemisorption

Pt(Cu) : moderate ε_d downshift and adsorption affinity \rightarrow best performance



Towards the application of the method to practical catalysts

Impregnation



Pure Black Carbon (PB) (Barsukov and co-workers)





Pt and Au shell - bimetallic core (Pt-M, Au-M) electrocatalysts Towards the application of the method to practical catalysts 20 Voltammetric response (at 5 mV s⁻¹) of a 4 Pt(Cu)/Pure Black C electrode at +0.4 V vs. Aq/AqCl Voltammetry of Pt(Cu)/Pure Plack Carbon in 0.5 M MeOH +0.1 M HCIO4 3 in deaerated acid at 10 mV s⁻¹ 15 2 l_g / mAcm⁻² 1 i /mAcm⁻² 10 0 10 mA mg⁻¹ Pt -1 5 -2

1.15

-3

-4

-0.35

0.15

0.65

E / V vs Ag/AgCI



0.1

0.3

0.5

E / V vs Ag/AgCl



0.7